



#### 0.2A SCHOTTKY BARRIER DIODE CHIP SCALE PACKAGE

## **Product Summary**

V <sub>RRM</sub> (V)	I <sub>O</sub> (mA)	V <sub>F(MAX)</sub> (V) @ +25°C	I <sub>R(MAX)</sub> (mA) @ +25°C
30	200	0.50	0.05

## Description

The SDM0230CSP is a 30-volt 0.2A schottky barrier diode that is optimized for low forward voltage drop and low leakage current housed in a compact chip scale package (CSP) that occupies only 0.18mm<sup>2</sup> board-space. The low thermal resistance enables designers to meet design challenges of increasing efficiency whilst at the same time reducing board space. It is ideally suited for use in portable applications.

## **Applications**

- Blocking Diode
- Switching Diode
- Reverse Protection Diode
- Boost Diode

### **Features and Benefits**

- 0.18mm<sup>2</sup> footprint 70% smaller than DFN1006/SOD923
- Off board profile of 0.3mm more than 30% thinner than the DFN1006
- Low forward voltage of 0.50V (max) minimises power dissipation losses
- Low leakage maximises battery power
- · Soft, Fast Switching Capability
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: X3-WLCUS0603-3
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Dot
- Weight: 0.119mg



## Ordering Information (Note 4)

Part Number	Case	Packaging
SDM0230CSP-7	X3-WLCUS0603-3	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



X7 = Product Type Marking Code Dot denotes Cathode Pin



## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	30	V
Average Rectified Output Current	l <sub>0</sub>	0.2	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	4.5	Α

## **Thermal Characteristics**

Characteristic	Symbol	Value Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	$R_{ heta JA}$	261 °C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150 °C

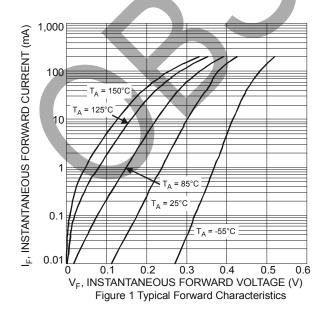
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

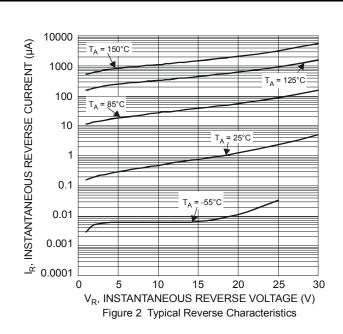
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
	V <sub>F</sub>	I	0.30	0.35	V	$I_F = 10 \text{mA}, T_J = +25 ^{\circ}\text{C}$
Forward Voltage Drop		I	0.42	0.50		$I_F = 200 \text{mA}, T_J = +25 ^{\circ}\text{C}$
		1	0.36	_		I <sub>F</sub> = 200mA, T <sub>J</sub> = +125°C
Lookaga Current (Note 6)	I <sub>R</sub>		_	50	μA	$V_R = 30V, T_J = +25^{\circ}C$
Leakage Current (Note 6)		7	1.5		mA	V <sub>R</sub> = 30V, T <sub>J</sub> = +125°C
Junction Capacitance	CJ		9		pF	$V_R$ = 15V, $T_J$ = +25°C , $f$ = 1MHz

Notes:

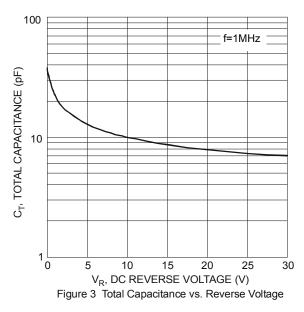
- 5. Device mounted on FR-4 substrate PC board, with minimum recommended pad layout per http://www.diodes.com/datsheets/ap02001.pdf.
- 6. Short duration pulse test used to minimize self-heating effect.

## **Typical Electrical Characteristics**



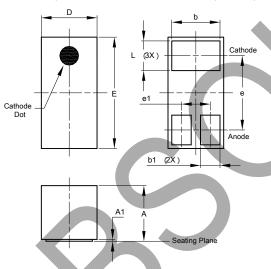






# **Package Outline Dimensions**

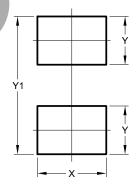
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



X3-WLCUS0603-3					
Dim	Min	Max	Тур		
Α	0.24	0.30	_		
A1	0.00	0.01	_		
b	0.23	0.29	0.26		
b1	0.075	0.135	0.105		
D	0.290	0.300	0.295		
Е	0.590	0.600	0.595		
е	_	_	0.40		
e1	_	_	0.155		
L	0.13	0.19	0.16		
All Dimensions in mm					

# Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)	
X	0.30	
Υ	0.21	
Y1	0.60	



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